Special Issue Smart Systems (SmaSys2021)

Message from the Guest Editors

We are planning to publish a Special Issue on "Smart Systems" related to the International Conference of Smart Systems Engineering (SmaSys2021, http://smasys.yz.yamagata-u.ac.jp/2021/) held on 7-8 October 2021 in Yonezawa, Japan. This Special Issue provides opportunities for collaboration across a wide range of fields and technologies related to emerging smart systems. Smart systems regard broad scientific and engineering fields. They include organic materials, organic electronics, organic devices, biomaterials, biomedical and biosystem engineering, electrical engineering and informatics, mechanical systems engineering, smart flexible structures and systems, green materials and their processing, tourism engineering with agriculture and foods, and new engineering education. All the participants of SmaSys2021 and their colleagues—especially students are encouraged to submit their works to this Special Issue.

Guest Editors

Prof. Dr. Bungo Ochiai

Prof. Dr. Go Matsuba

Prof. Dr. Tomoya Higashihara

Dr. Sathish K. Sukumaran

Dr. Kohei Osawa

Deadline for manuscript submissions

closed (31 March 2022)



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Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that Technologies becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, Technologies will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

Editor-in-Chief

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